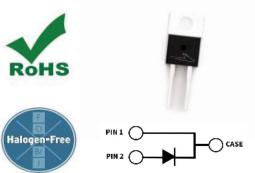


4th Generation 1200 V, 10 A Silicon Carbide Schottky Diode

Description

With the performance advantages of a Silicon Carbide (SiC) Schottky Barrier diode, power electronics systems can expect to meet higher e iciency standards than Si-based solutions, while also reaching higher frequencies and power densities. SiC diodes can be easily paralleled to meet various application demands, without concern of thermal runaway. In combination with the reduced cooling requirements and improved thermal performance of SiC products, SiC diodes are able to provide lower overall system costs in a variety of diverse applications.



Package Types: TO-220-2 Marking: C4D10120A

Features

- Low Forward Voltage (V_F) Drop with Positive Temperature Coe icient
- Zero Reverse Recovery Current / Forward Recovery Voltage
- Temperature-Independent Switching Behavior

Applications

- Industrial Switched Mode Power Supplies
- Uninterruptible & AUX Power Supplies
- Boost for PFC & DC-DC Stages
- Solar Inverters

Maximum Ratings ($T_C = 25^{\circ}C$ Unless Otherwise Specified)

Parameter	Symbol	Value	Unit	Test Conditions	Notes
Repetitive Peak Reverse Voltage	V _{RRM}	1200			
DC Blocking Voltage	V _{DC}	1200	V		
Continuous Forward Current	I _F	33	A	T _J = 25 °C	Fig. 3
		16		T _J = 135 °C	
		10		T _J = 156 °C	
Repetitive Peak Forward Surge Current	I _{FRM}	47		$T_{\rm C} = 25$ °C, $t_{\rm p} = 10$ ms, Half Sine Wave	
		31.5		$T_{\rm C} = 110$ °C, $t_{\rm p} = 10$ ms, Half Sine Wave	
Non-Repetitive Forward Surge Current	l _{FSM}	71		$T_{\rm C} = 25$ °C, $t_{\rm p} = 10$ ms, Half Sine Wave	Fig. 8
		59.5		$T_{\rm C} = 110 {\rm ^{\circ}C}$, $t_{\rm p} = 10 {\rm ms}$, Half Sine Wave	
Non-Repetitive Peak Forward Surge Current	 F,Max	750		$T_{c} = 25 {}^{\circ}\text{C}, t_{p} = 10 \mu\text{s}, \text{Pulse}$	
		620		T _C = 110°C, t _p = 10 μs, Pulse	
Power Dissipation	P _{tot}	166.5	W	T _J = 25 °C	Fig. 4
		72		T _J = 110 °C	
i²t Value	i²t	25	A²s	$T_{\rm C} = 25 {\rm ^{\circ}C}, t_{\rm p} = 10 {\rm ms}$	
		17.5		$T_{\rm C} = 110^{\circ} \text{C}, t_{\rm p} = 10 \text{ ms}$	

Electrical Characteristics

Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Notes
Forward Voltage		1.5	1.8	V	I _F = 10 A, T _j = 25 °C	
	V _F	2.2	3		I _F = 10 A, T _j = 175 °C	Fig. 1
Reverse Current		30	250	μА	V _R = 1200 V, T _j = 25 °C	O
	I _R	55	350		V _R = 1200 V, T _j = 175 °C	Fig. 2
Total Capacitive Charge	Q _c	52		nC	$V_R = 800 \text{ V}, T_j = 25 \text{ °C}$	Fig. 5
		754			$V_R = 0 \text{ V}, T_j jj$	
Total Capacitance	С			pF		

Typical Performance

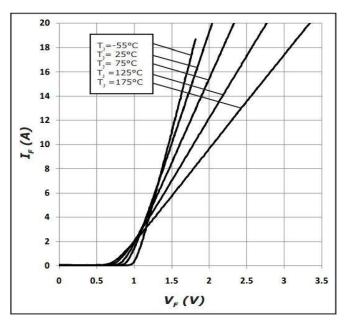


Figure 1 Forward Characteristics

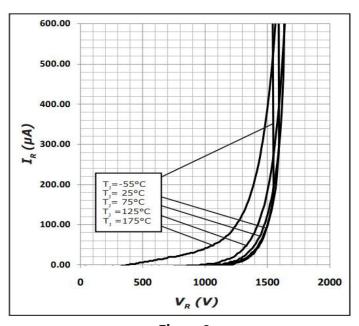


Figure 2
Reverse Characteristics

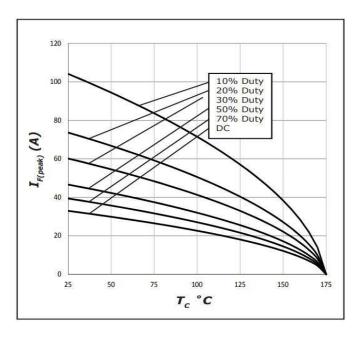


Figure 3Current Derating

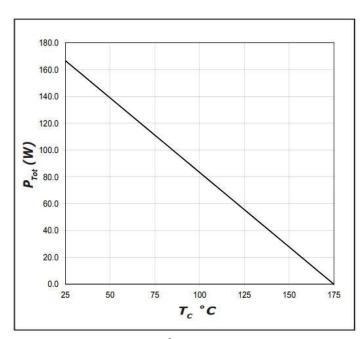


Figure 4Power Derating

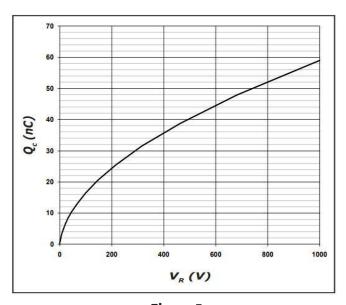


Figure 5Total Capacitance vs. Reverse Voltage

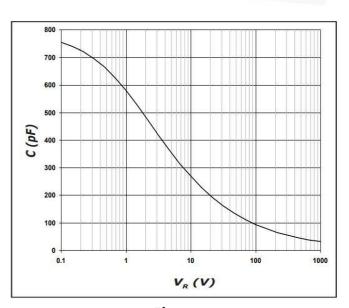


Figure 6Capacitace vs. Reverse Voltage

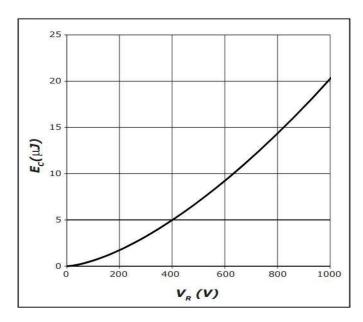


Figure 7Capacitance Stored Energy

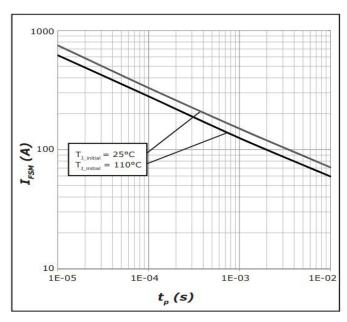


Figure 8

Non-Repetitive Peak Forward Surge Current versus Pulse Duration (sinusoidal waveform)

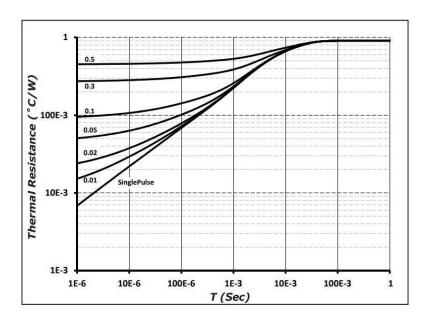
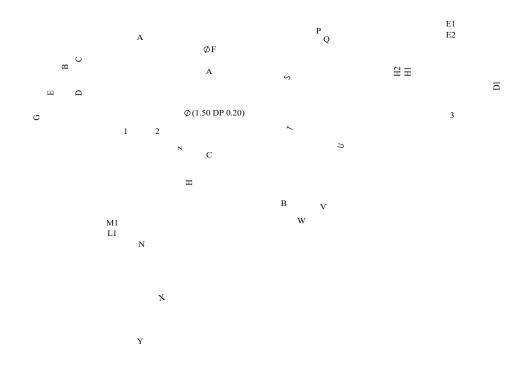


Figure 9
Transient Thermal Impedance

Package Dimensions & Pin-Out

Package: TO-220-2



NOTE

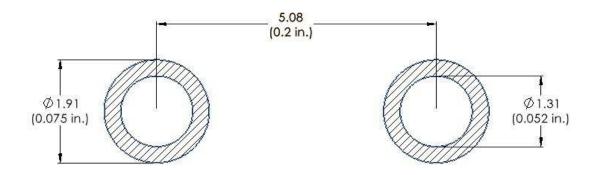
- 1. ALL METAL SURFACES ARE TIN PLATED (MATTE), EXCEPT AREA OF CUT.
- $\begin{tabular}{ll} 2. & DIMENSIONING \& TOLERANCING CONFORM TO \\ & ASME Y14.5M-1994. \end{tabular}$
- 3. ALL DIMENSIONS ARE LISTED IN MILLIMETERS. ANGLES ARE IN DEGREES.
- 4. PACKAGE BURR FLASH SIZE (0.5 mm) IS NOT INCLUDED IN THE DIMENSIONS



Recommended Solder Pad Layout

Primary dimensions shown in mm.

Learn more about recommended soldering profiles in this application note.



Product Ordering Information

Order Number	Packing Type
C4D10120A	Tube

Learn more about power device packing & shipment information in this application note.

Revision History

Document Version	Date of Release	Description of Changes
1	October-2016	Initial Release
5	March-2023	Update Package Drawing Update Landing Pad

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